

# Measurement of Photoelectron Yield at KEK PF

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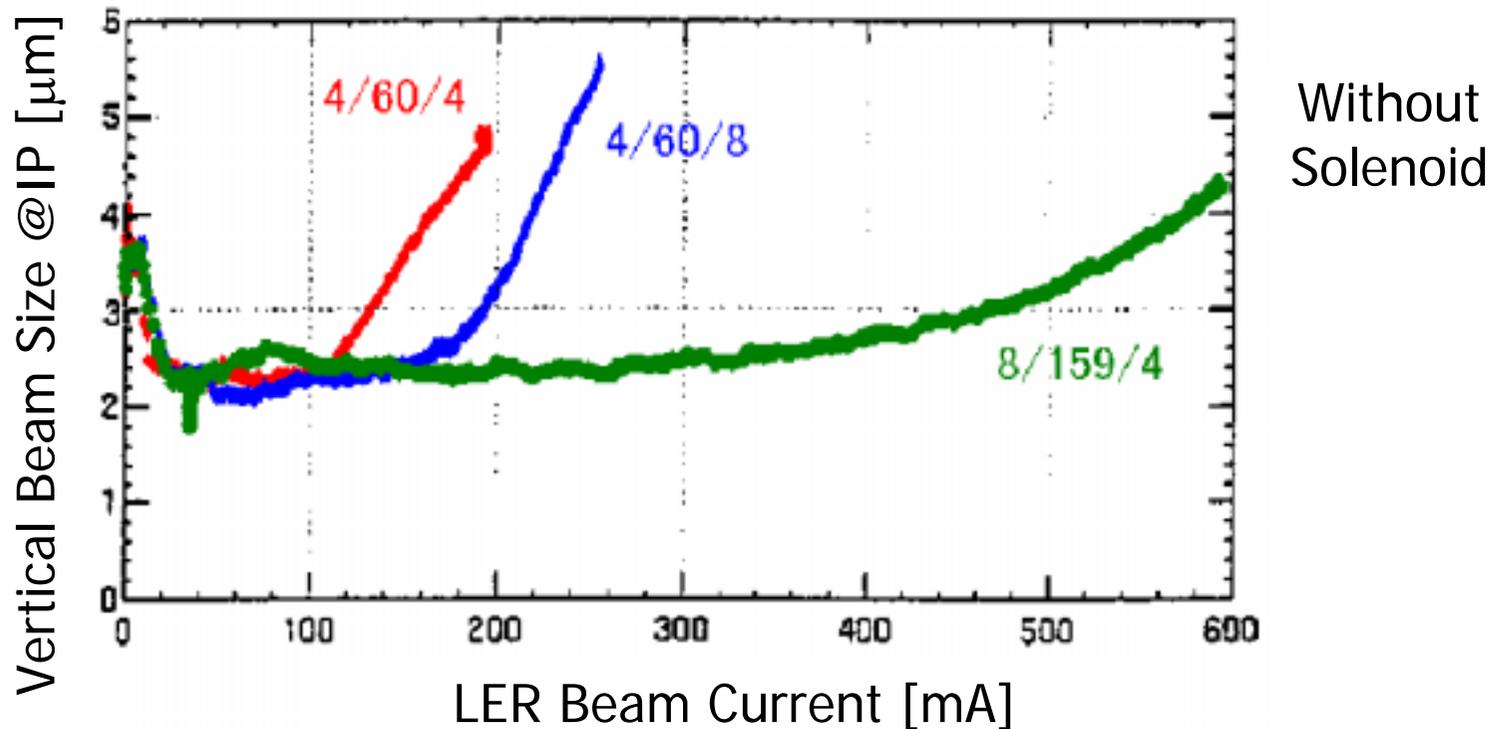
12/Sep/2001

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# Introduction

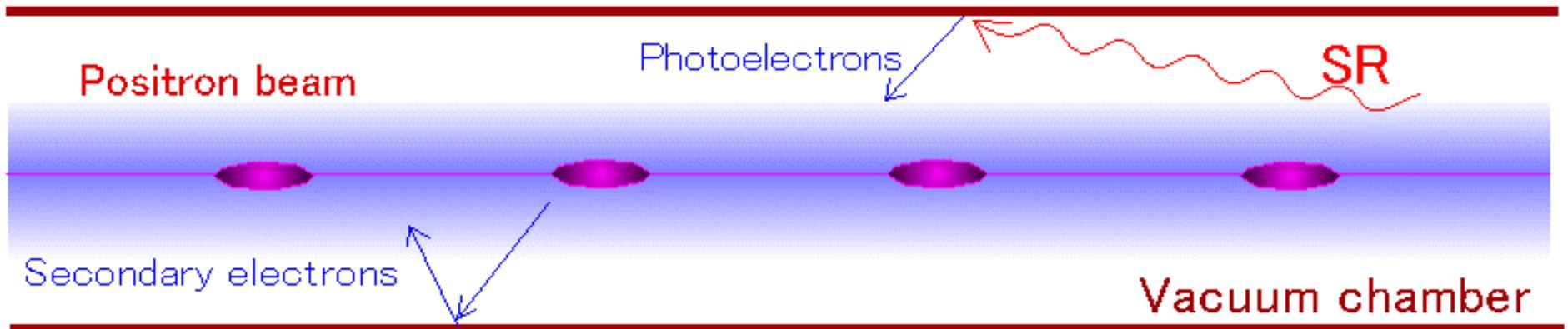
- One of the latest serious problems for KEKB is a beam size blow up of the positron beam.



The symbol of 4/60/8, for an example, means that the beam consists of 4 trains of 60 bunches filled with every 8 RF buckets spacing (16 ns).

# Introduction - 2

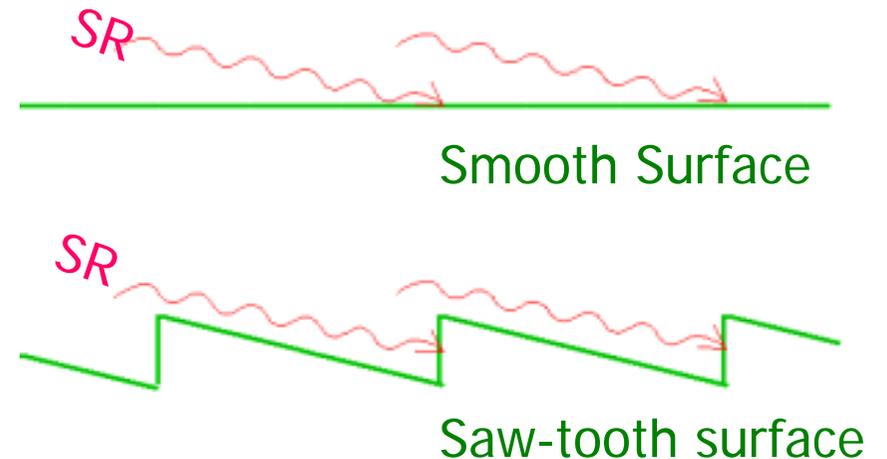
- The blow up is considered to be caused by a single-beam instability due to an electron cloud around the positron beam.



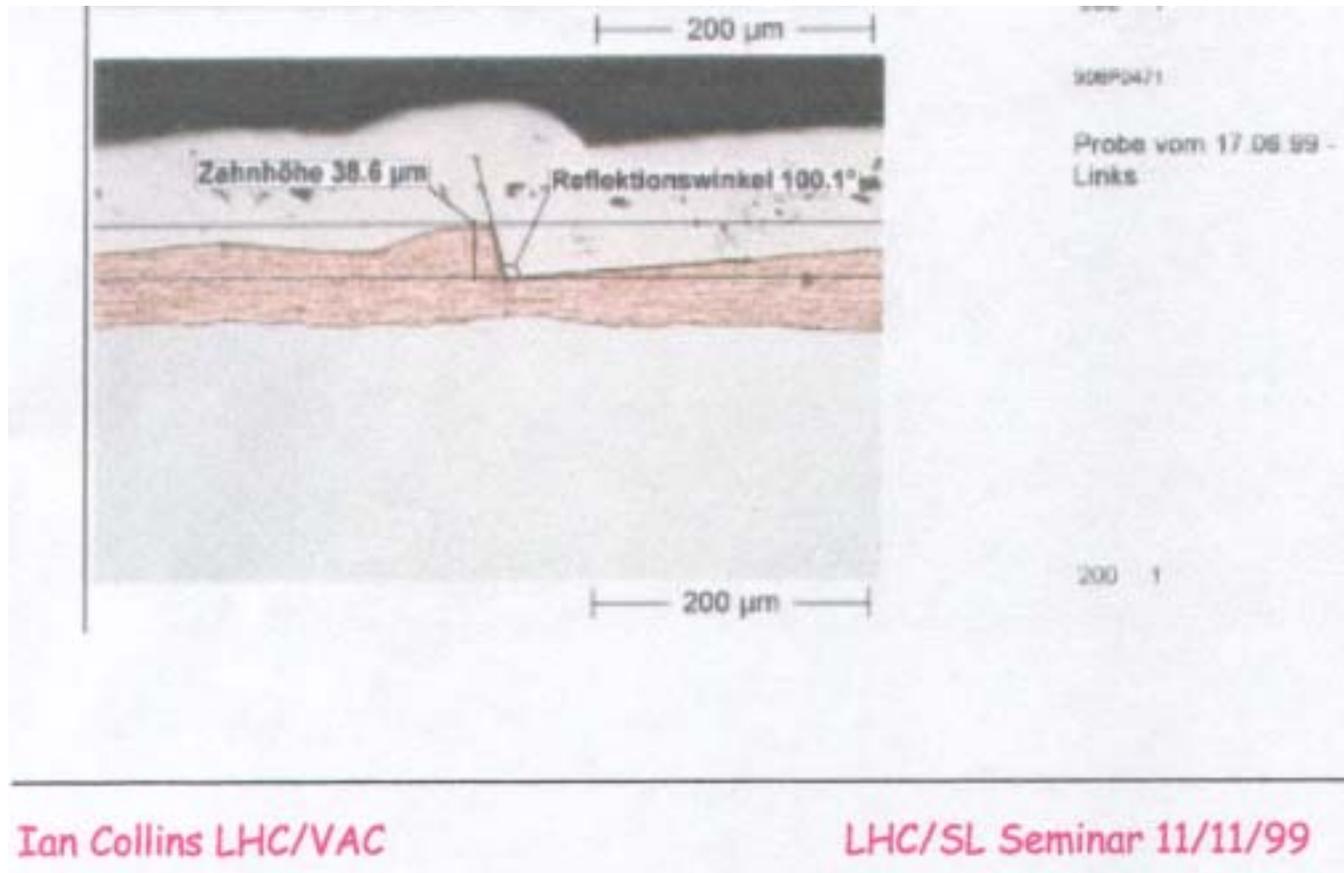
- The seed of the electron cloud is mainly the photoelectrons emitted from the chamber surface irradiated by synchrotron radiation (SR). Some electrons may be multiplied by multipactoring.

# Purpose of Experiment

- Consider a saw-tooth surface as a promising method to reduce the photoelectron yield. The reduction was verified by SR with small critical energy at CERN (45-195 eV).
- Measure the photoelectron yield using the SR with a critical energy of 4.1 keV from the KEK Photon Factory (PF) using a test chamber and find the effect of the saw-tooth surface and its availability to the LER.
- Also investigate the spatial distribution of photoelectrons, the effect of positive potential and external magnetic fields.



# Saw-Tooth tested at CERN

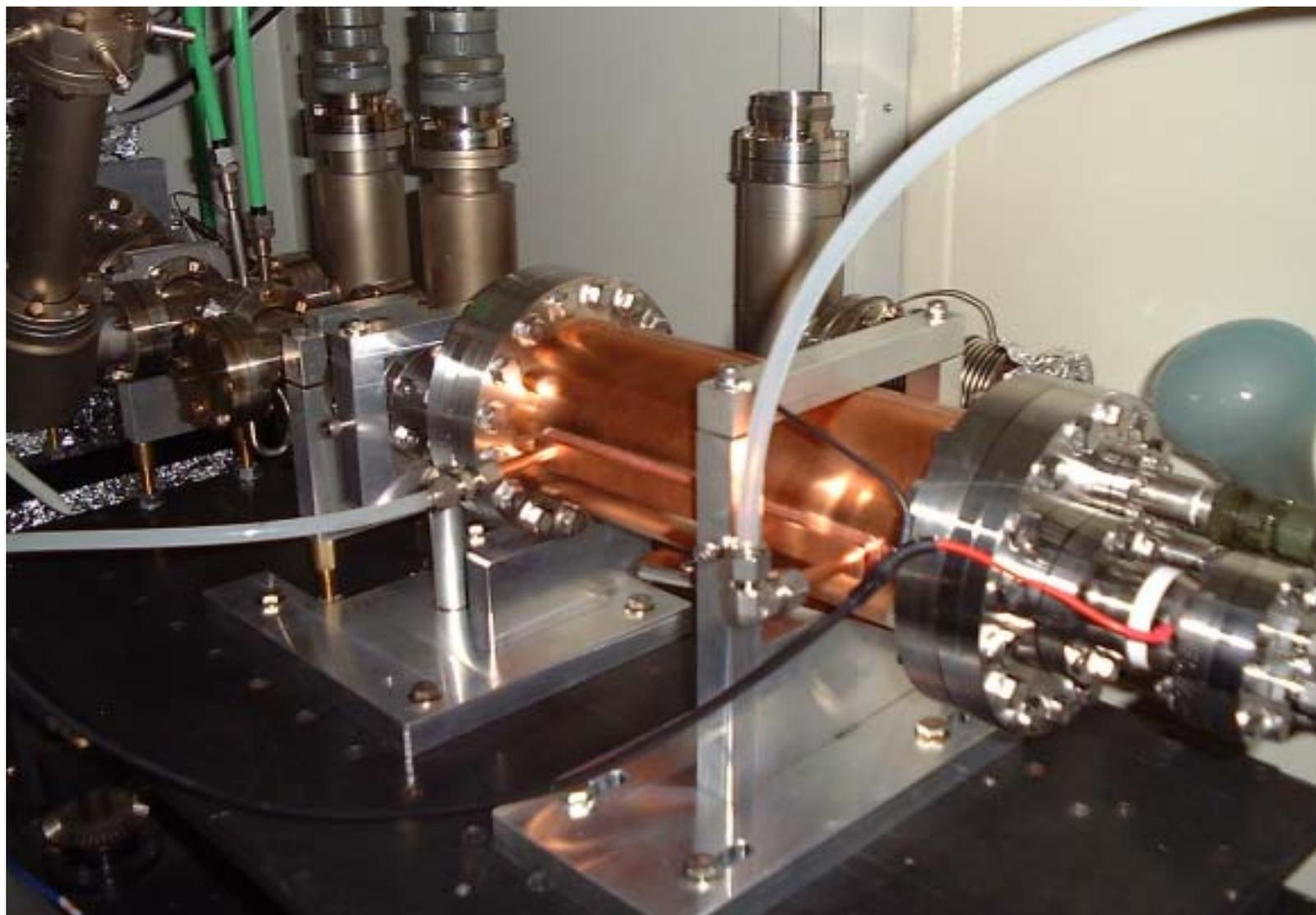


Ian Collins LHC/VAC

LHC/SL Seminar 11/11/99

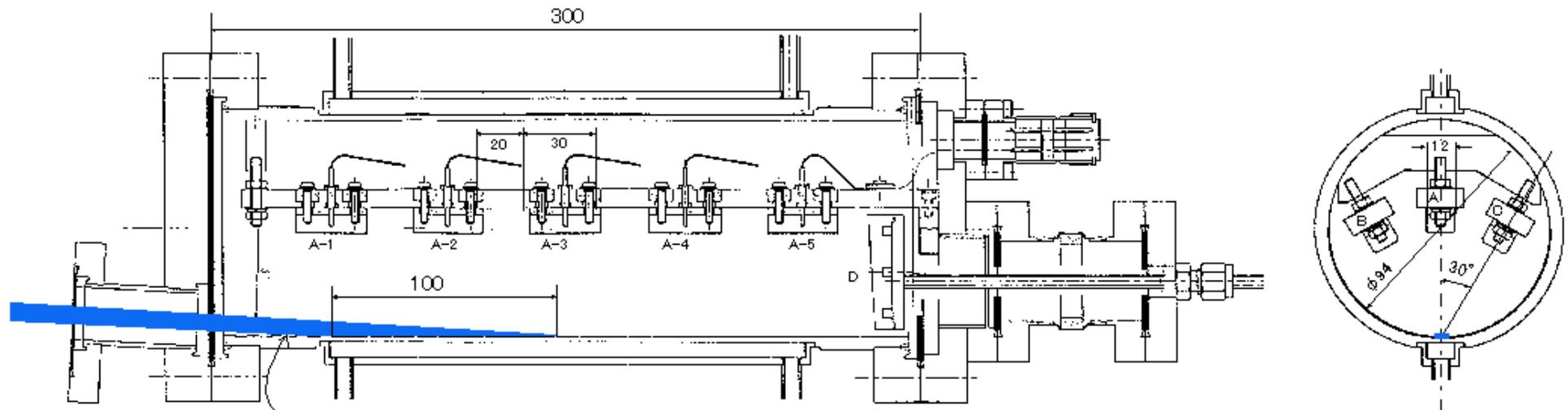
† I.R.Collins and F.Zimmermann,  
“Electron Cloud Investigation, Electron Cloud Simulation”, in  
LHC/SL Seminar, 11/11/99, <http://wwwslap.cern.ch/collective>.

# Test Chamber at Beam Line



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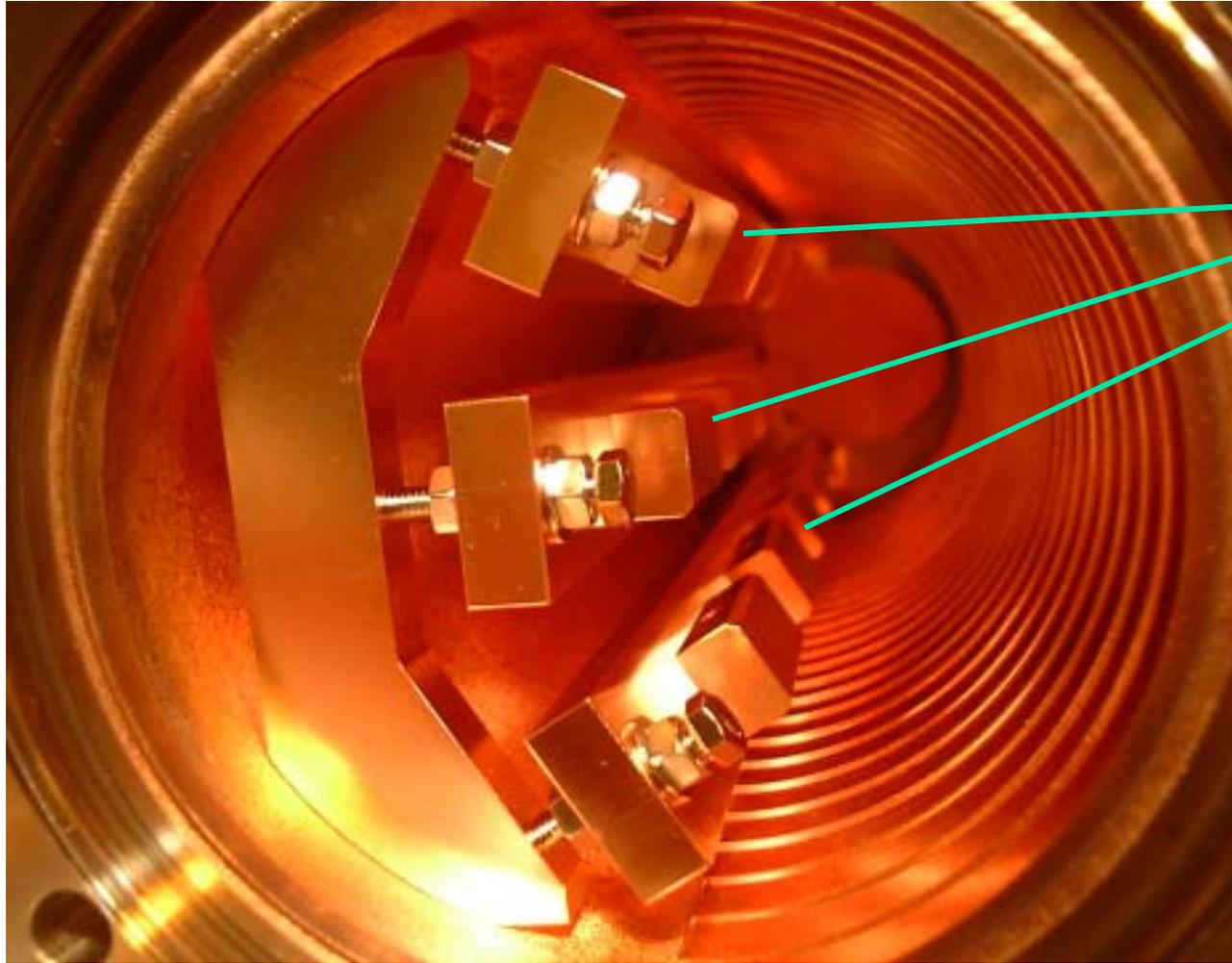
# Inside of Test Chamber



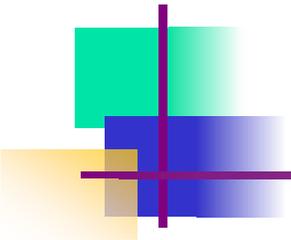
Synchrotron Radiation (SR):  
Critical energy = 4.1 keV  
Cross section = 5mm x 5mm  
Incident angle = 3°

- The total photon number is about  $4.9 \times 10^{13}$  photons  $s^{-1}$  for a unit beam current in mA.
- 15 copper electrodes (12 mm x 30 mm), five rows axially (No.1-No.5) and three lines azimuthally (A,B,C), are arranged above the irradiated surface.

# Inside of Test Chamber



Electrodes

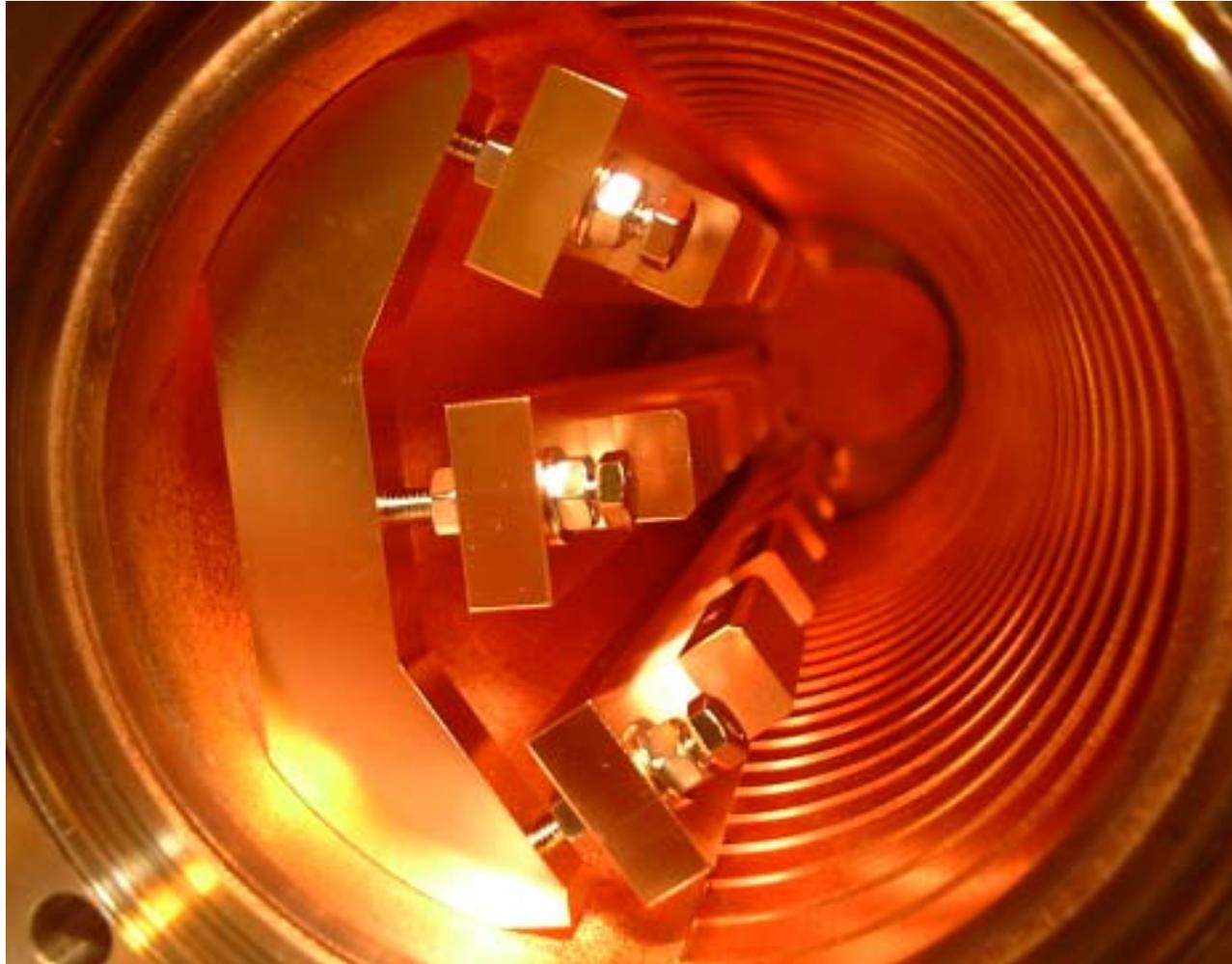


# Surfaces Prepared

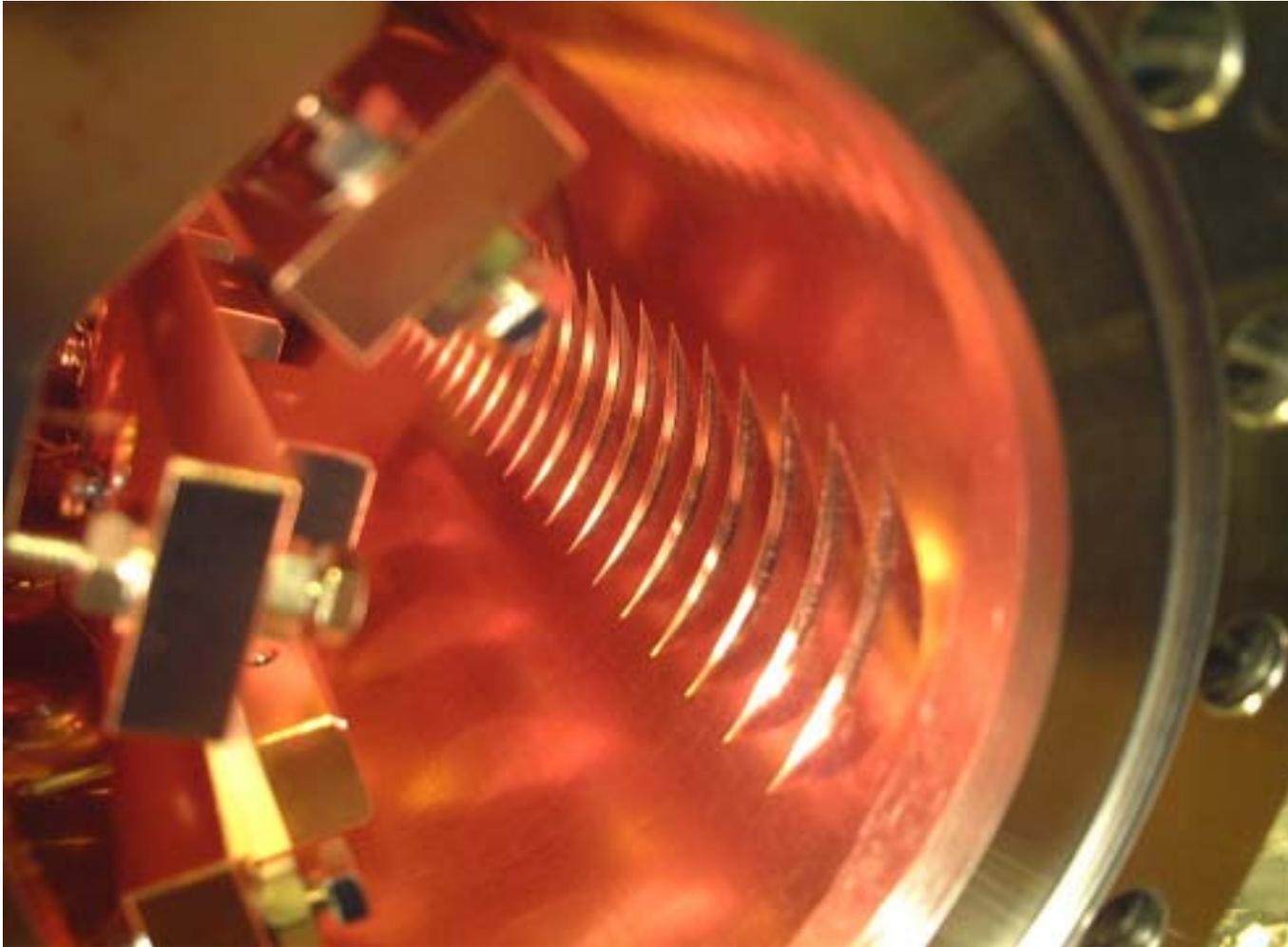
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- (1)[Saw-tooth\_1] The saw-tooth surface with a pitch and a depth of 10 mm and 1 mm, respectively. The machining was performed for a half of the chamber surface.
- (2)[Saw-tooth\_2] The saw-tooth surface is the same as (1), but machining was done only for about 20 mm width around the irradiated area.
- (3)[Machining ( $R_a = 7$ )] The surface was lathed azimuthally with a mean roughness ( $R_a$ ) of about 7.
- (4)[Smooth ( $R_a = 0.02$ )] A cold-drawn chamber same as that used for the LER.

# Saw-tooth 1

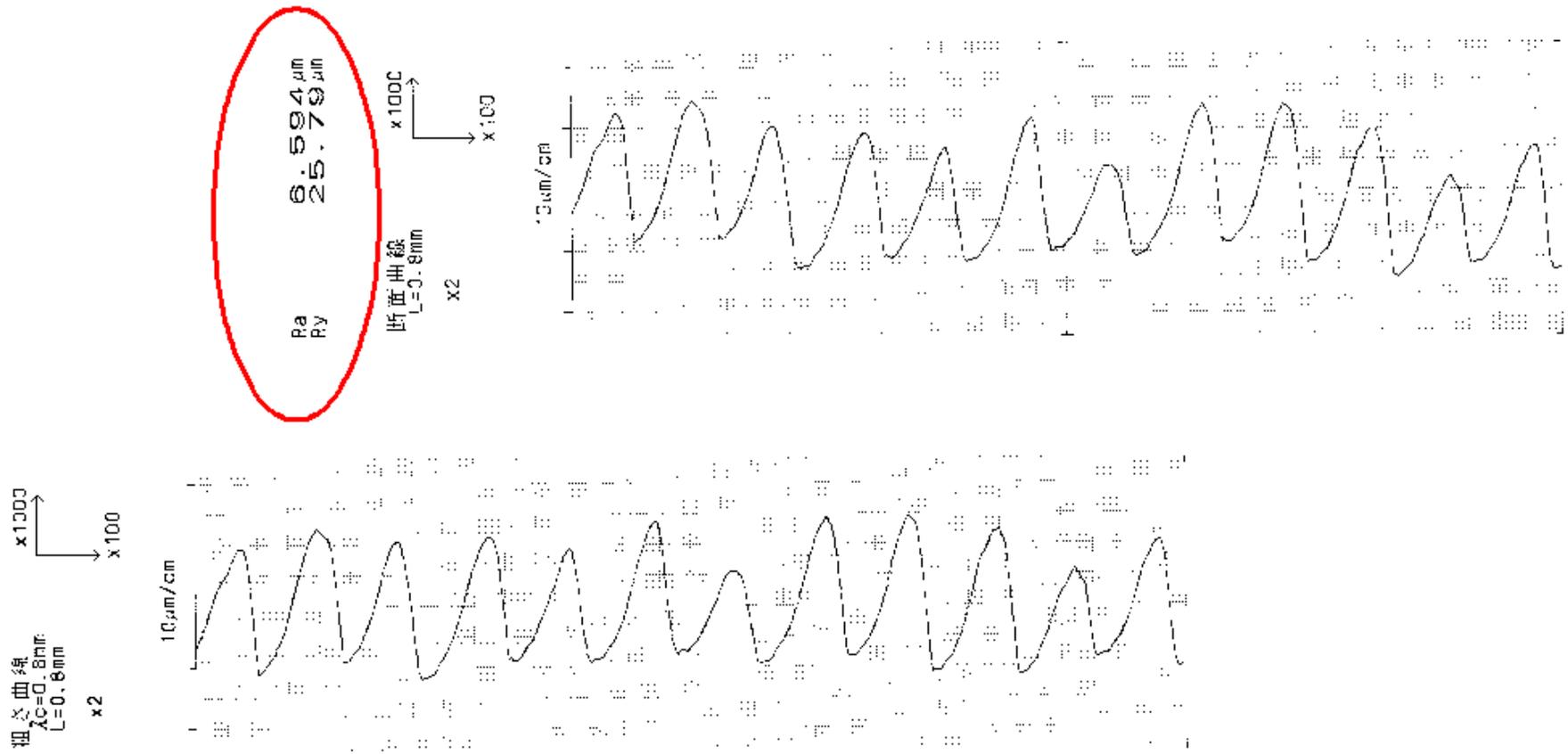


# Saw-tooth 2



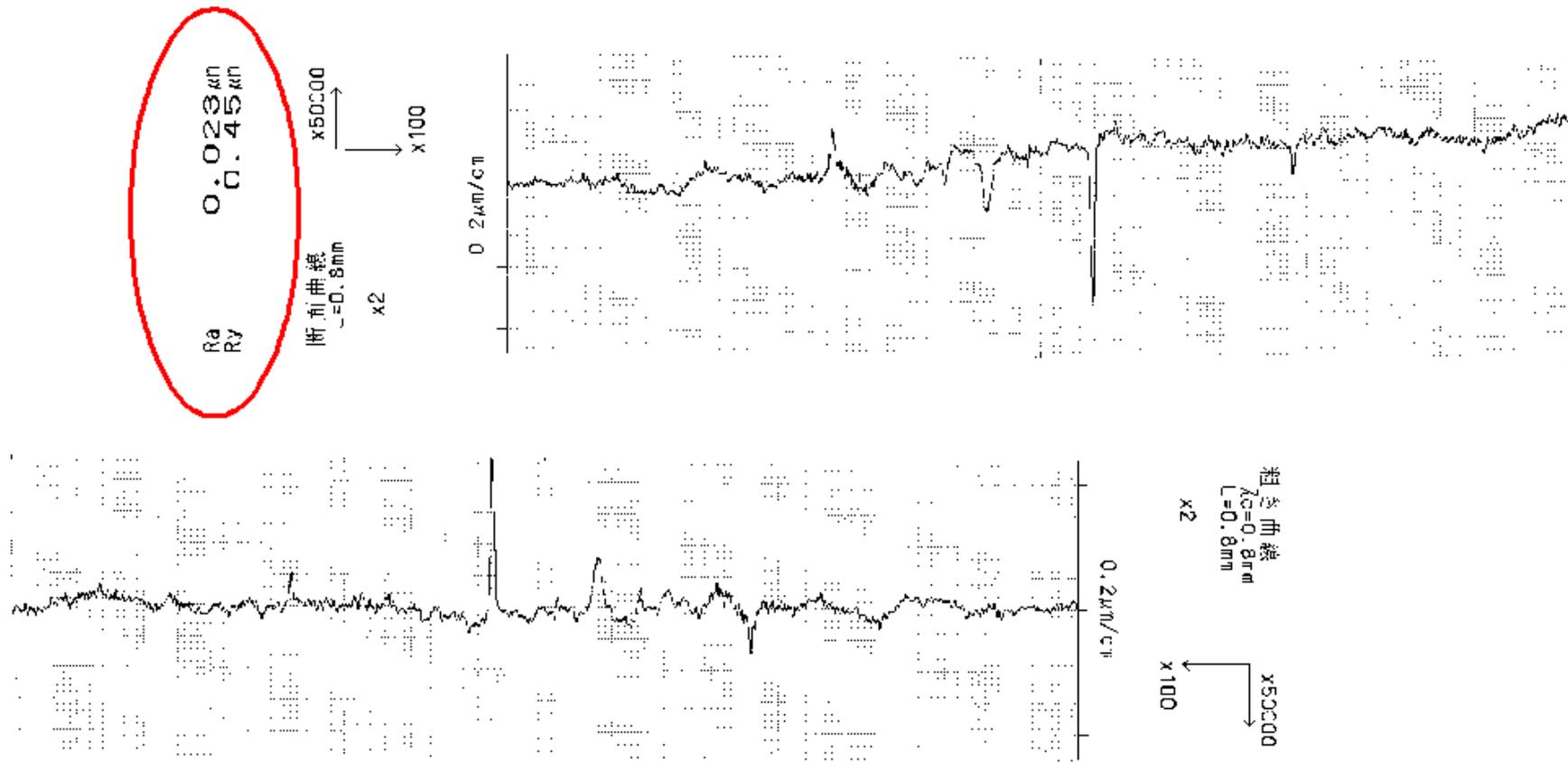
# Machined Surface

- Axial Roughness



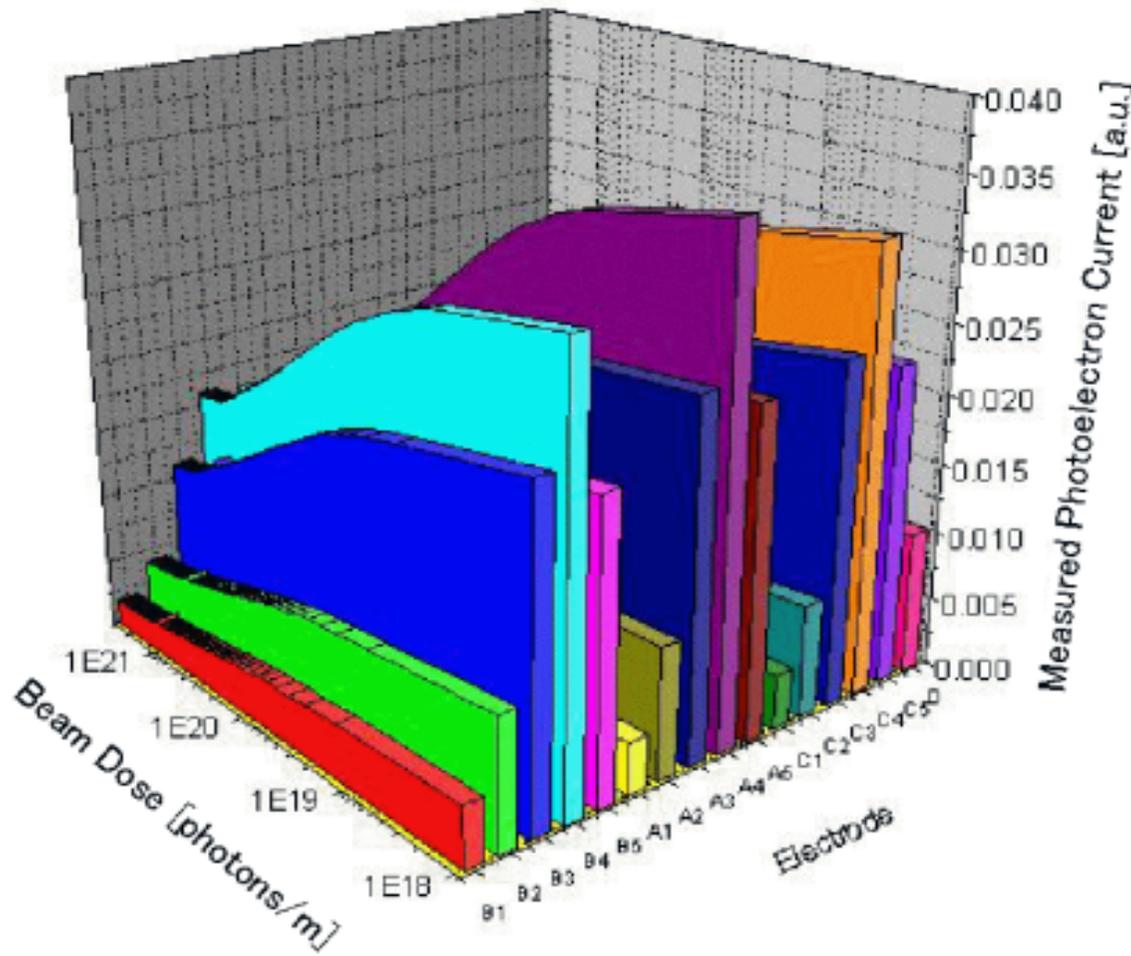
# Smooth Surface

- Axial Roughness



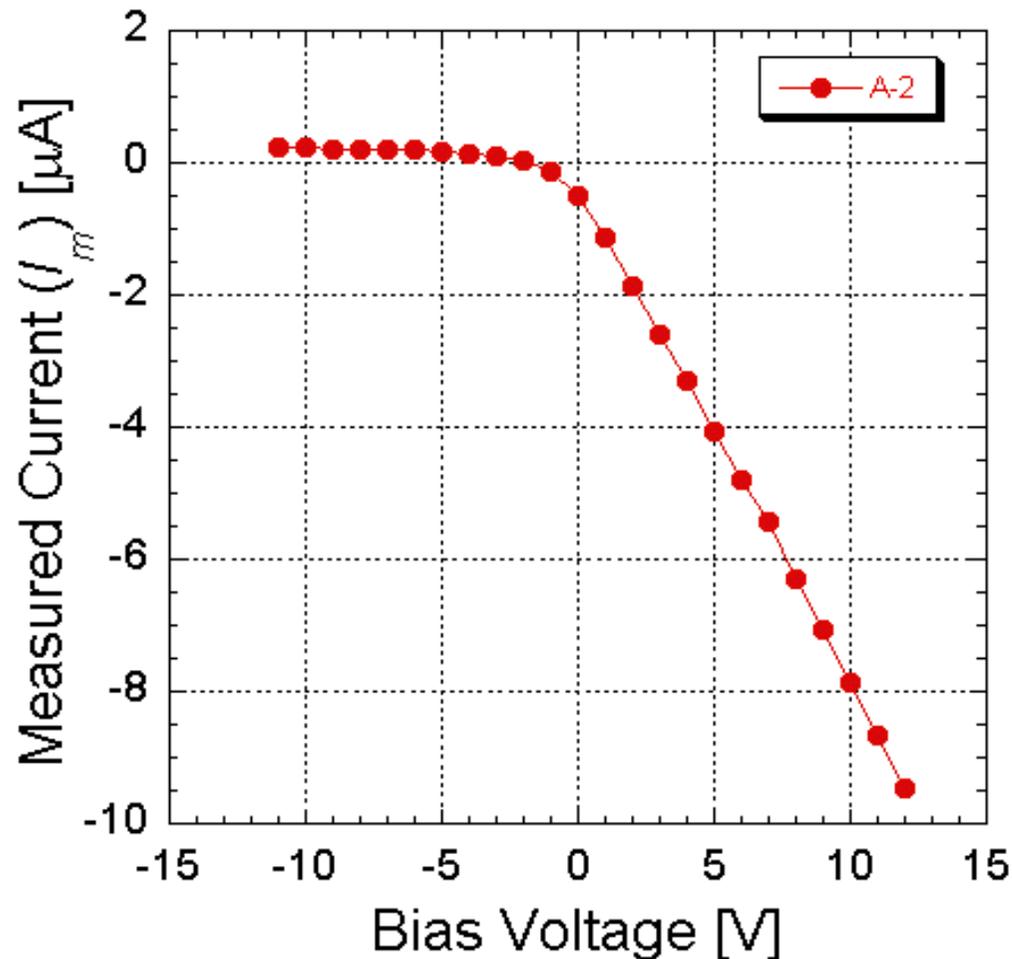
# Measured Current

- Change of measured currents against beam dose



- The following measurements were performed after the integrated photon irradiation of about  $3 \times 10^{21}$  photons  $m^{-1}$ , where the photoelectron yield settled down to almost a constant value.

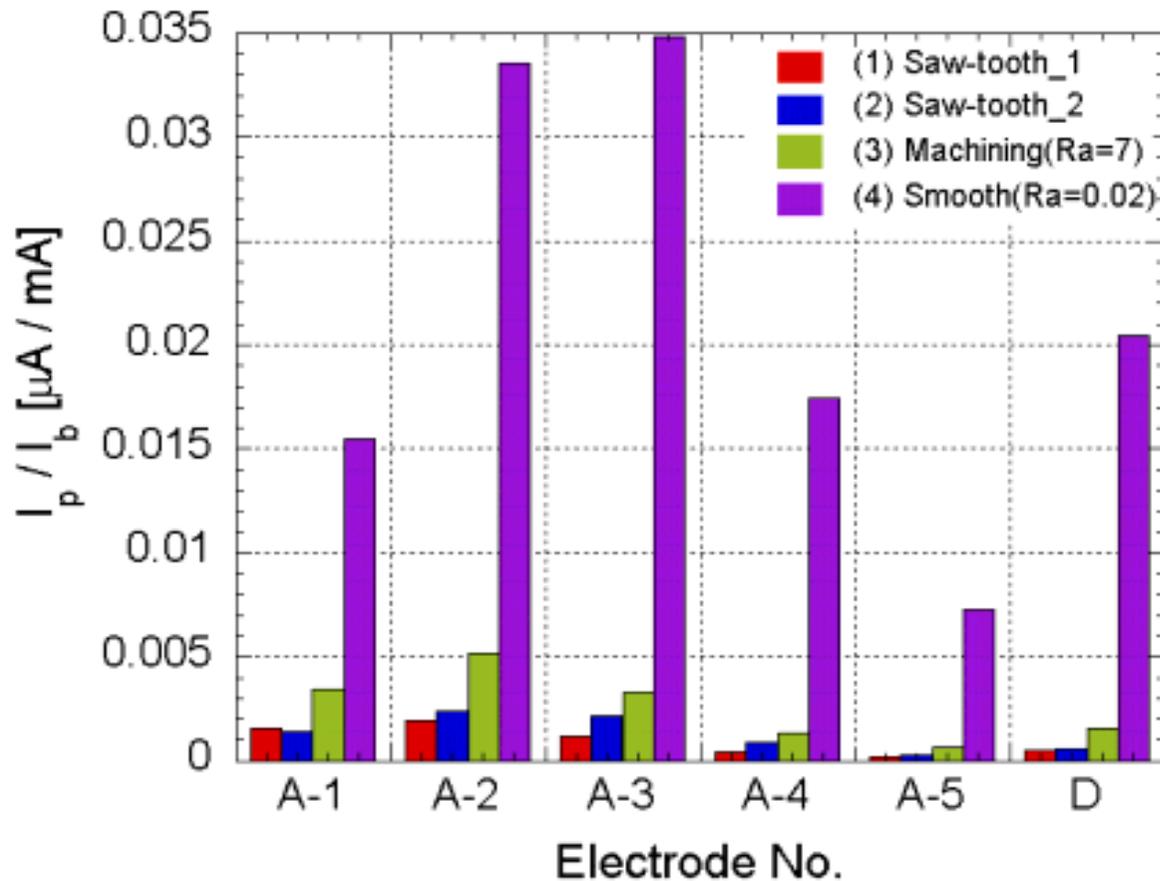
# Photoelectron Energy



■ For a negative voltage, the current saturates at less than 5 eV. This indicates that the energy of photoelectrons is almost less than 5 eV.

■ Here, we define the current due to only the photoelectrons (photoelectron current,  $I_p$ ) by  $I_p = I_m(0 \text{ V}) - I_m(-11 \text{ V})$ , where  $I_m(0 \text{ V})$  and  $I_m(-11 \text{ V})$  are the measured current at a bias voltage of 0 V and -11 V, respectively.

# Photoelectron Current



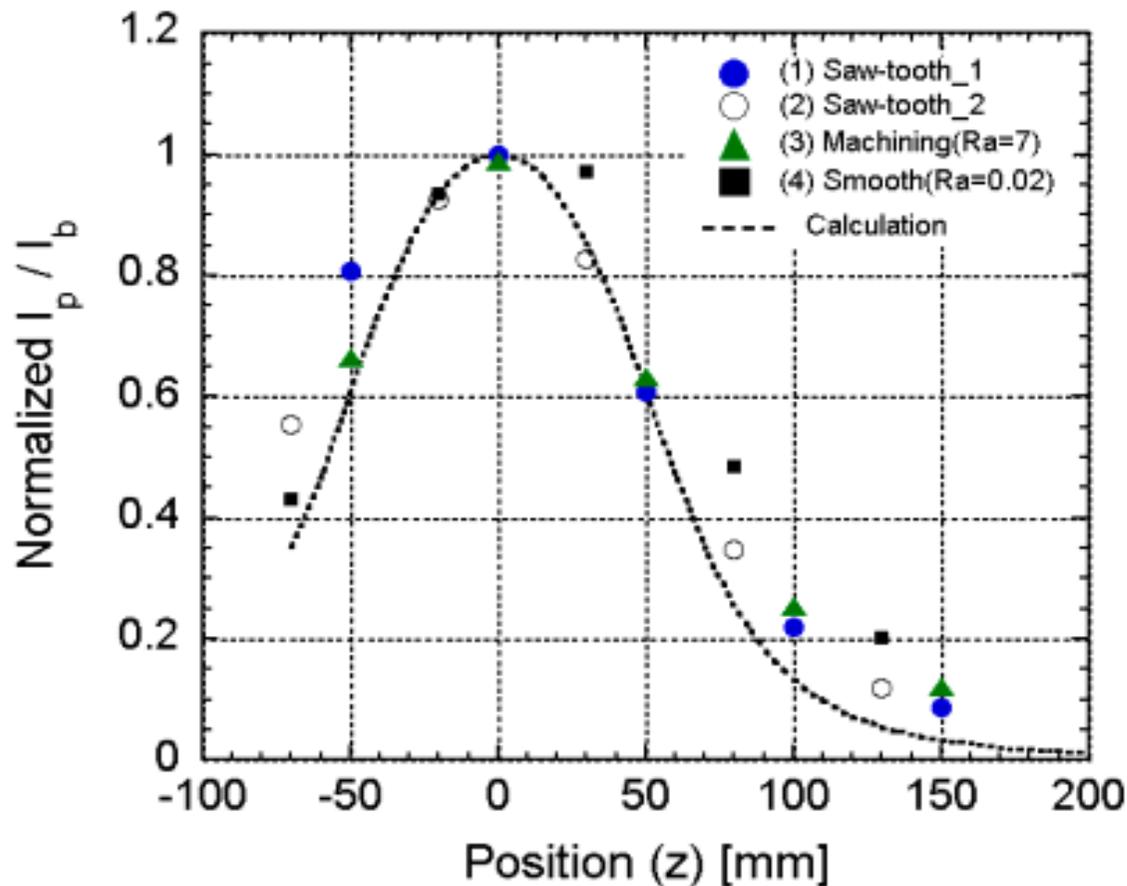
$I_b$  : Beam Current

■ For the saw-tooth (1) and (2), the peak value is less than 6% of the smooth surface (4).

■ Two saw-tooth surfaces, (1) and (2), have almost the same value but slightly smaller for the case (1).

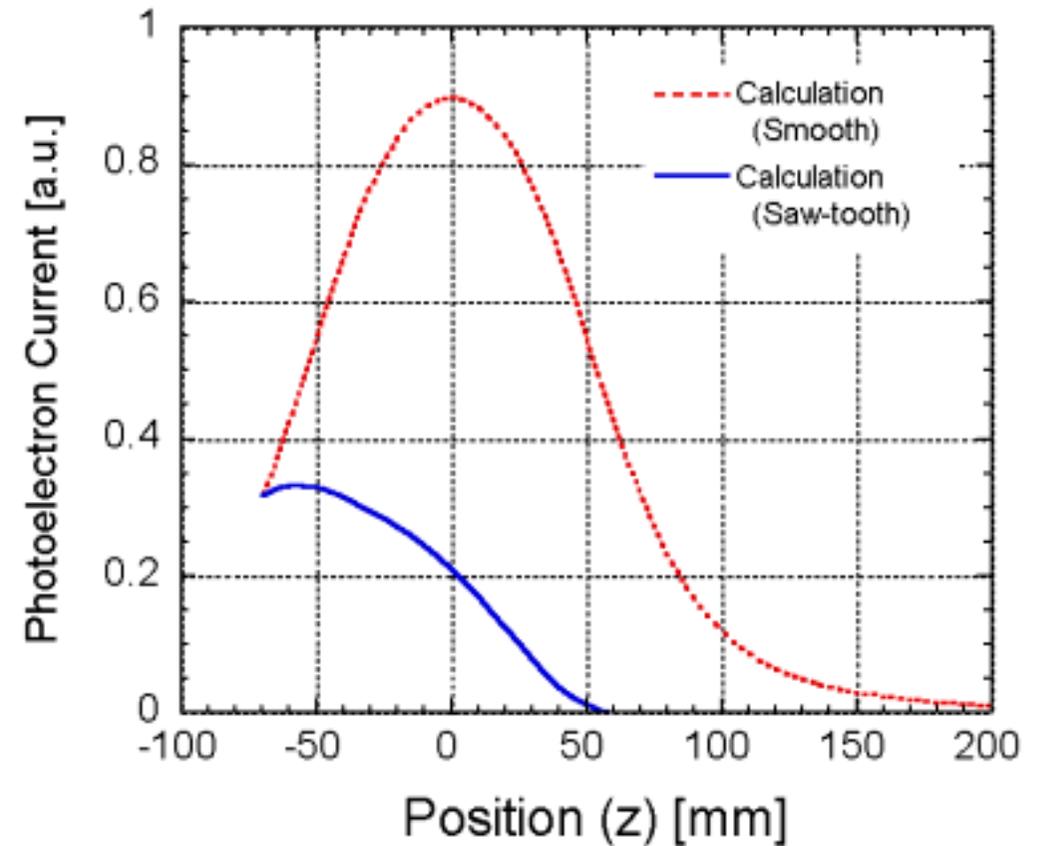
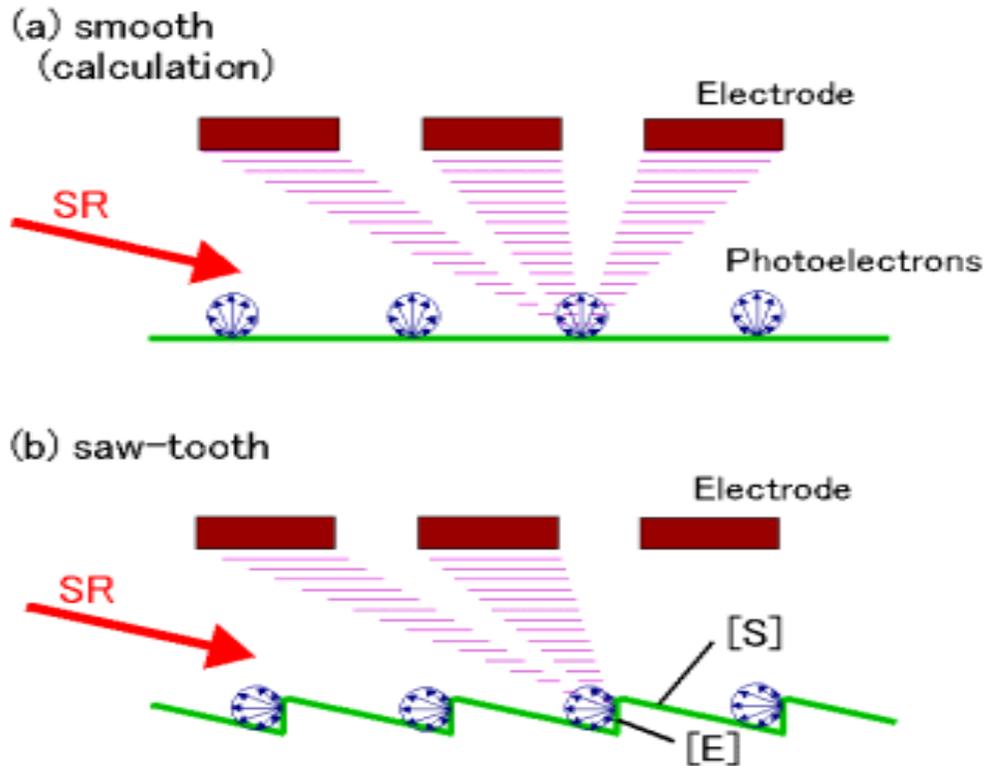
■ Even for the machined surface (3), the peak value is about 14% of the smooth surface (4). This means that a rough surface with a roughness of  $R_a = 7$  serves as also a shallow but effective saw-tooth surface.

# Axial Distribution



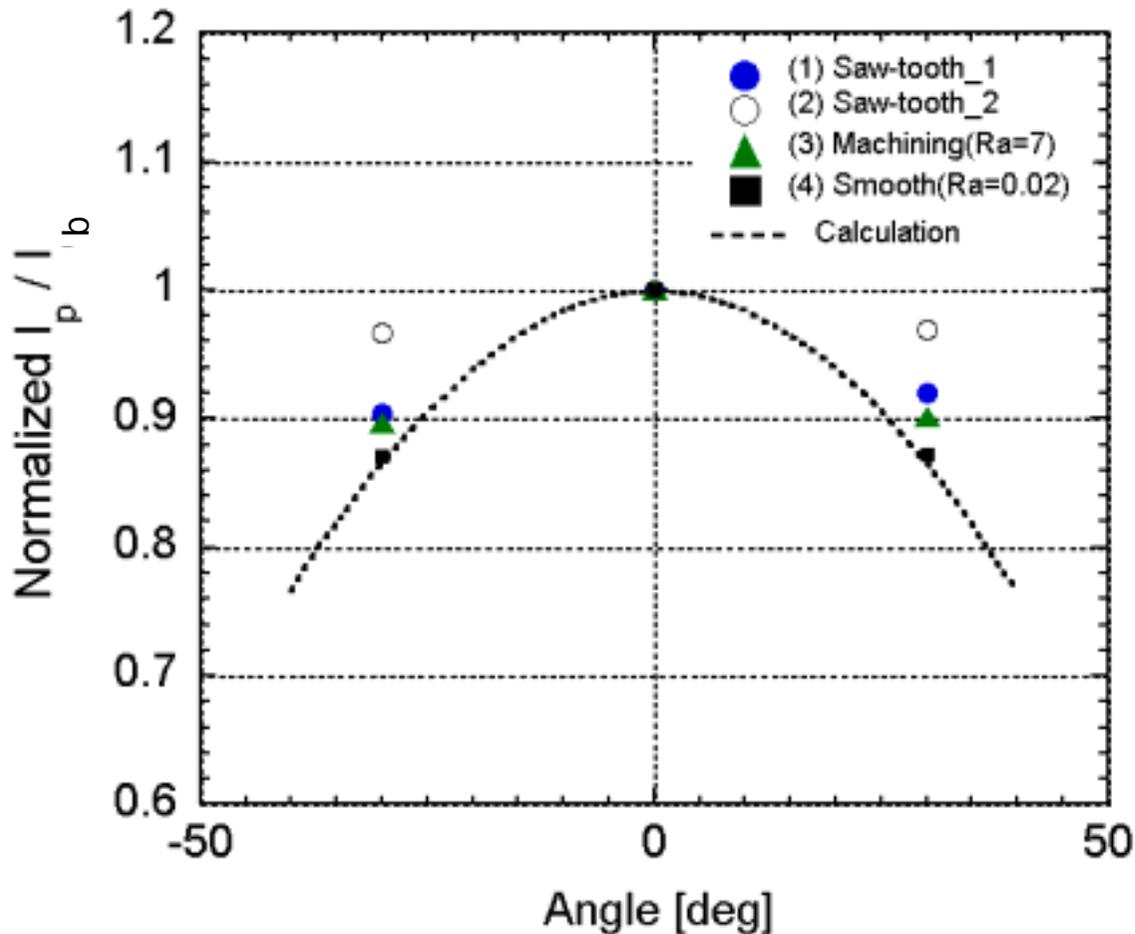
- The values are normalized by those near to the center of the irradiated area ( $z = 0$ ).
- The dotted line is the calculated one assuming that the photoelectrons are emitted following the cosine law from only the directly irradiated area.
- Approximately the measured distribution indicates that the photoelectrons are emitted following the cosine law despite quite different surface structures.

# Ideal Model



For the ideal case, the measured photoelectron distribution should be different for the smooth and saw-tooth surface. There may be some effects of scattered photons.

# Azimuthal Distribution



■ Azimuthal distribution of  $I_p$  was also measured and that for the case (4) was almost the same as the calculation using the cosine law.

■ For the cases (1) – (3), especially for the case (2), the azimuthal distribution was flatter than the calculation.

# Photoelectron Yield ( $\eta$ )

- Here  $\eta$  is calculated assuming that the photoelectron emission follows the cosine law from smooth surface.

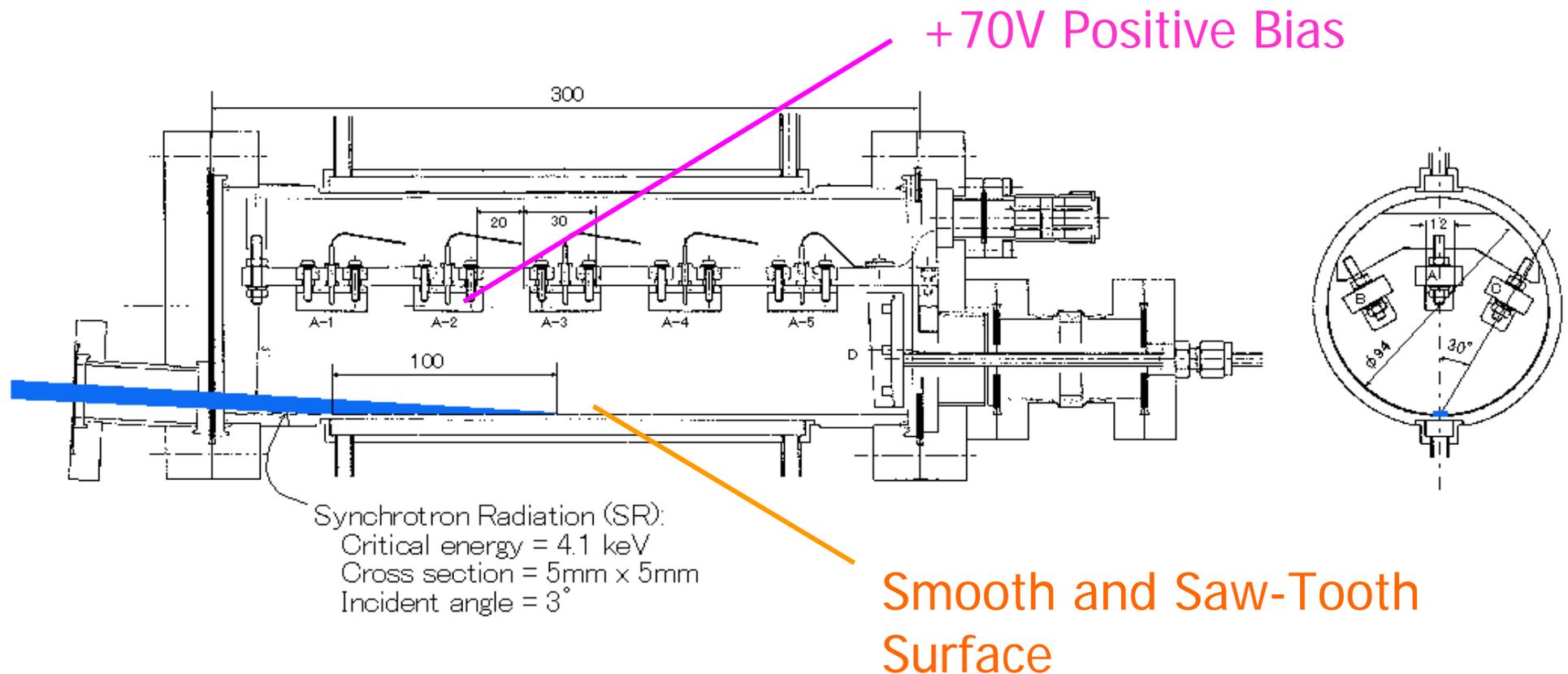
Critical Energy	4.1 keV			† 195 eV			† 45 eV		
Incident Angle	52 mrad			11 mrad			11 mrad		
	$\eta$	R [%]	$\eta^*$	$\eta$	R [%]	$\eta^*$	$\eta$	R [%]	$\eta^*$
Saw-Tooth	0.016	0.18	0.016	0.052	1.2	0.052	0.053	1.8	0.053
Machining	0.04	1.1	0.04						
Smooth	0.29	33.2	0.434	0.073	77	0.318	0.022	80.9	0.116

- $\eta^*$  is the effective photoelectron yield considering the reflectivity, R, and given by  $\eta/(1-R)$ .

† I.R.Collins and F.Zimmermann,

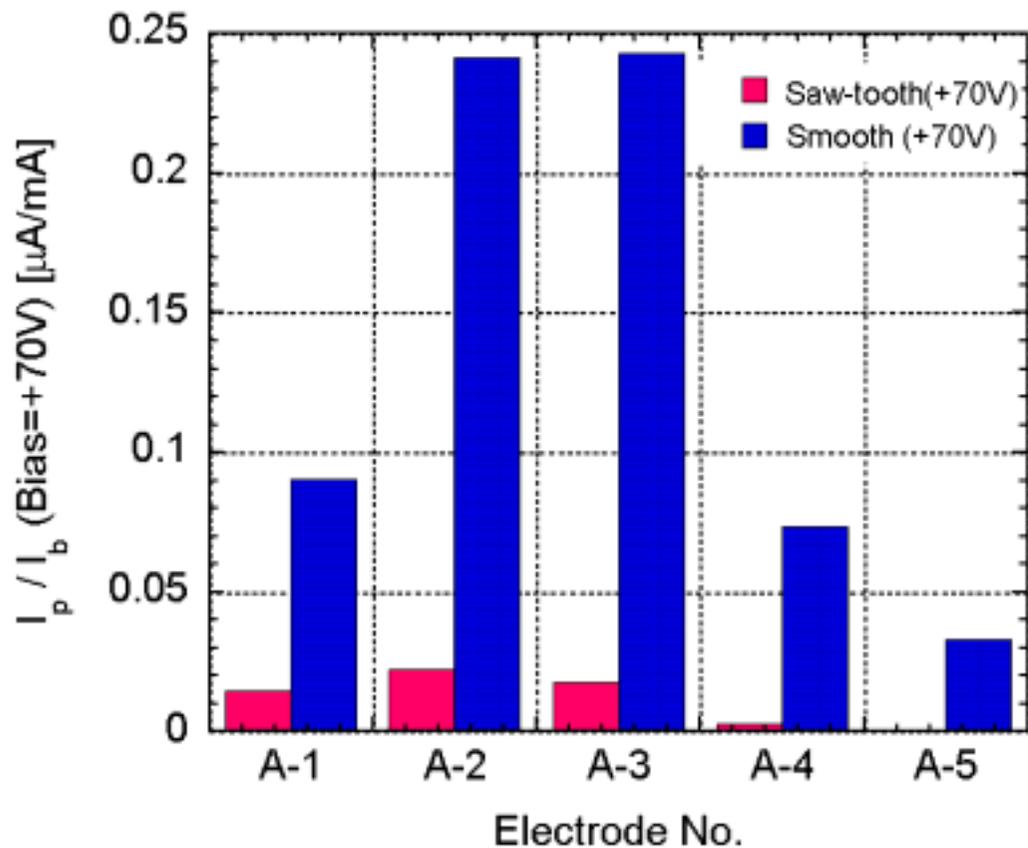
“Electron Cloud Investigation, Electron Cloud Simulation”, in LHC/SL Seminar, 11/11/99, <http://wwwslap.cern.ch/collective>.

# Effect of Positive Bias (Setup)



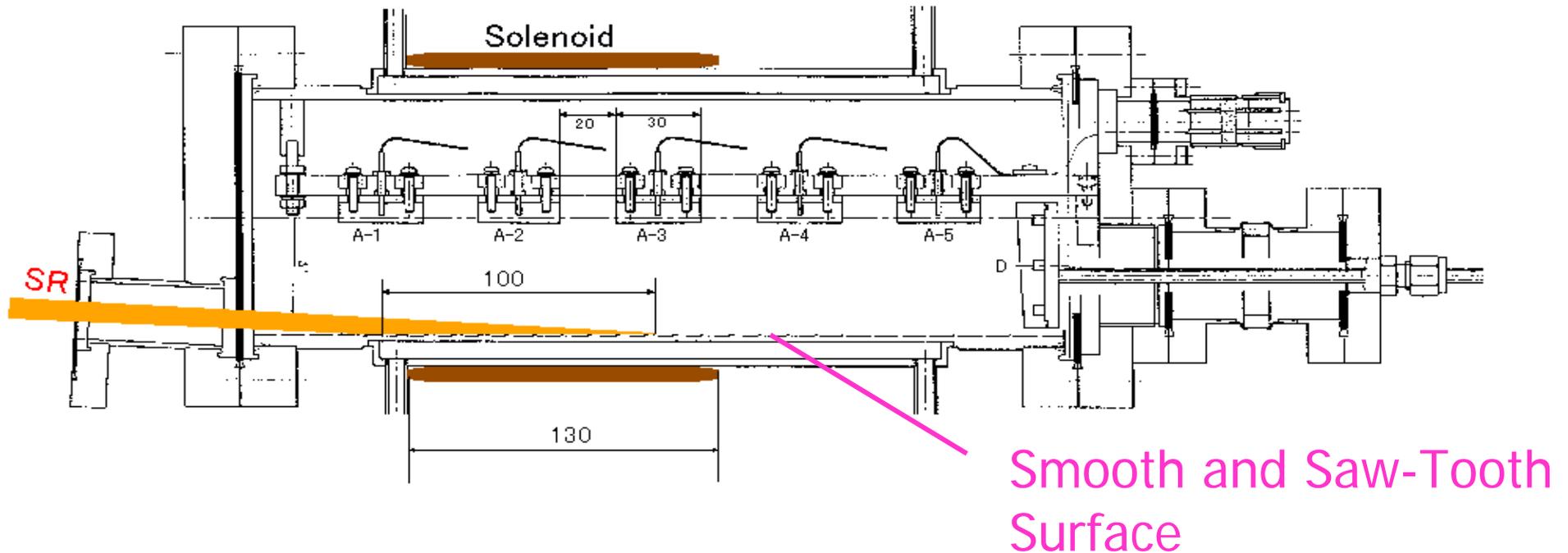
- Positive 70 V bias was applied assuming a positron beam.

# Effect of Positive Bias



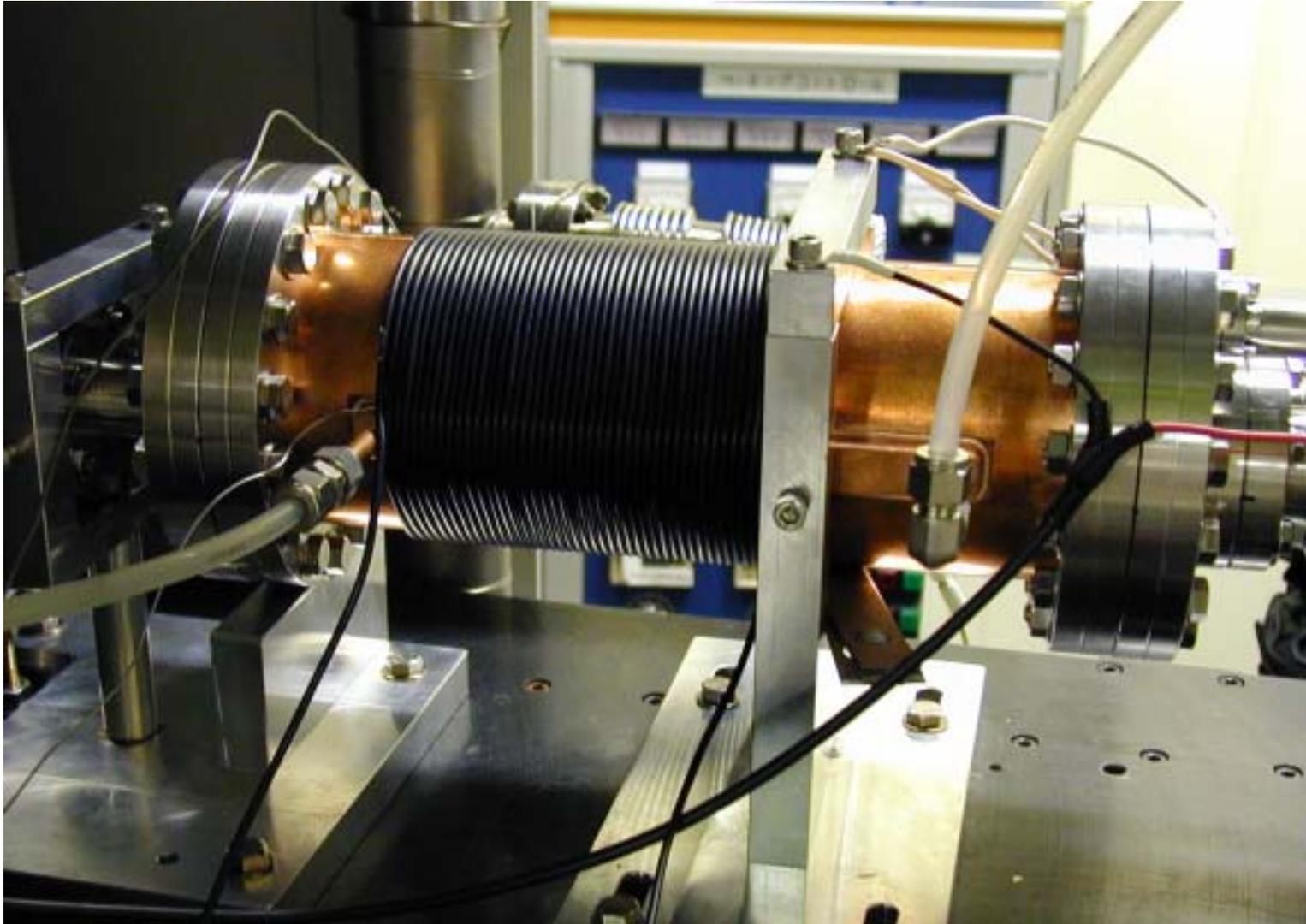
- Compared to the case without bias voltage, it is found that the  $I_p/I_b$  increased by one order of magnitude by applying +70 V for both surfaces.
- However, it should be noted that the reduction of practical photoelectron yield (= the photoelectron current measured at the beam position) by using the saw-tooth surface is still significant, less than 10 %.

# Effect of Solenoid Field (Setup)



- The solenoid field is also an effective method to reduce electrons around the beam (practical yield).
- The total solenoid length was about 130 mm. A typical axial magnetic field just near the surface is about 20 G at the solenoid current of 5 A.

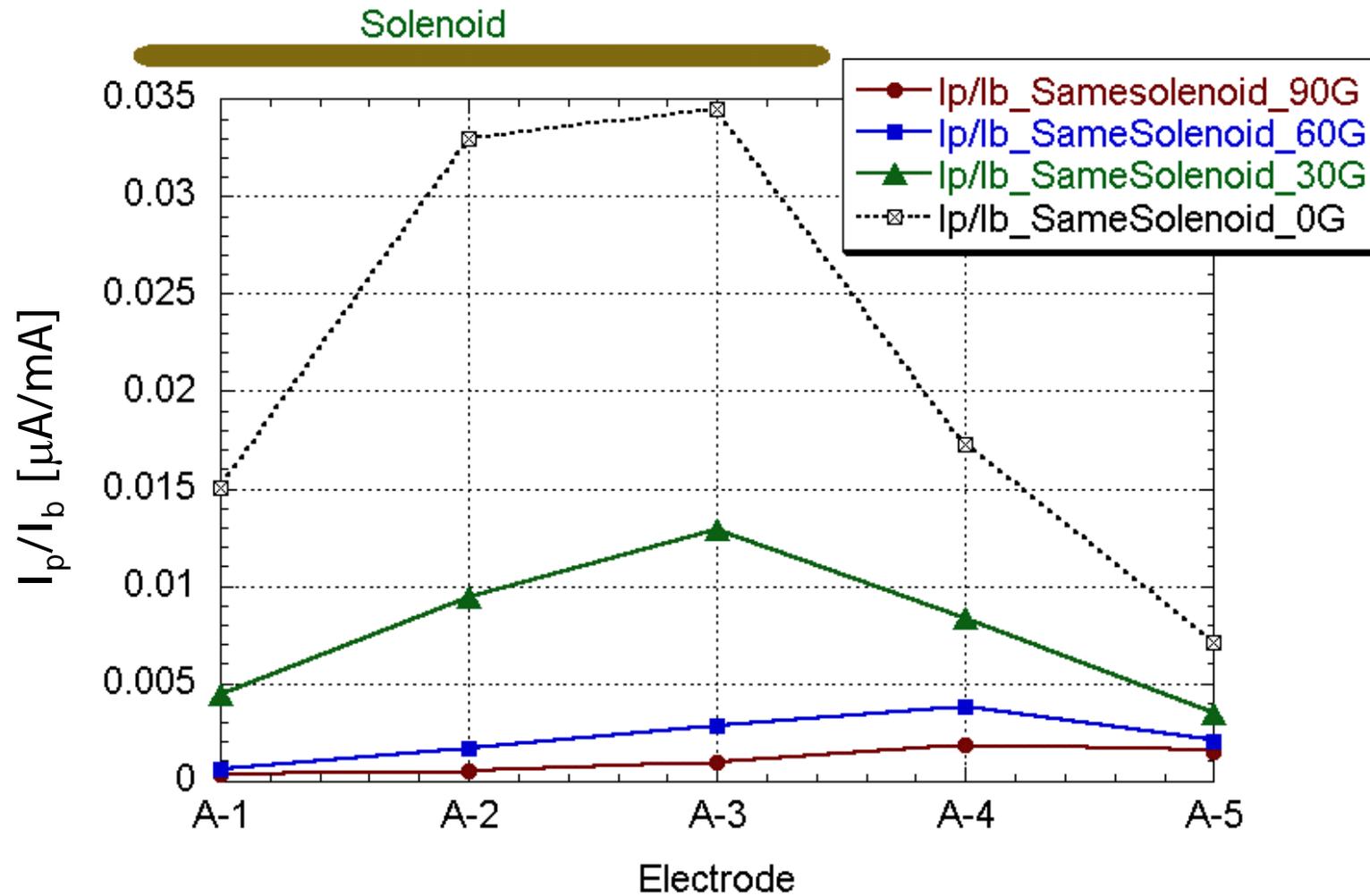
# Solenoid around Test Chamber



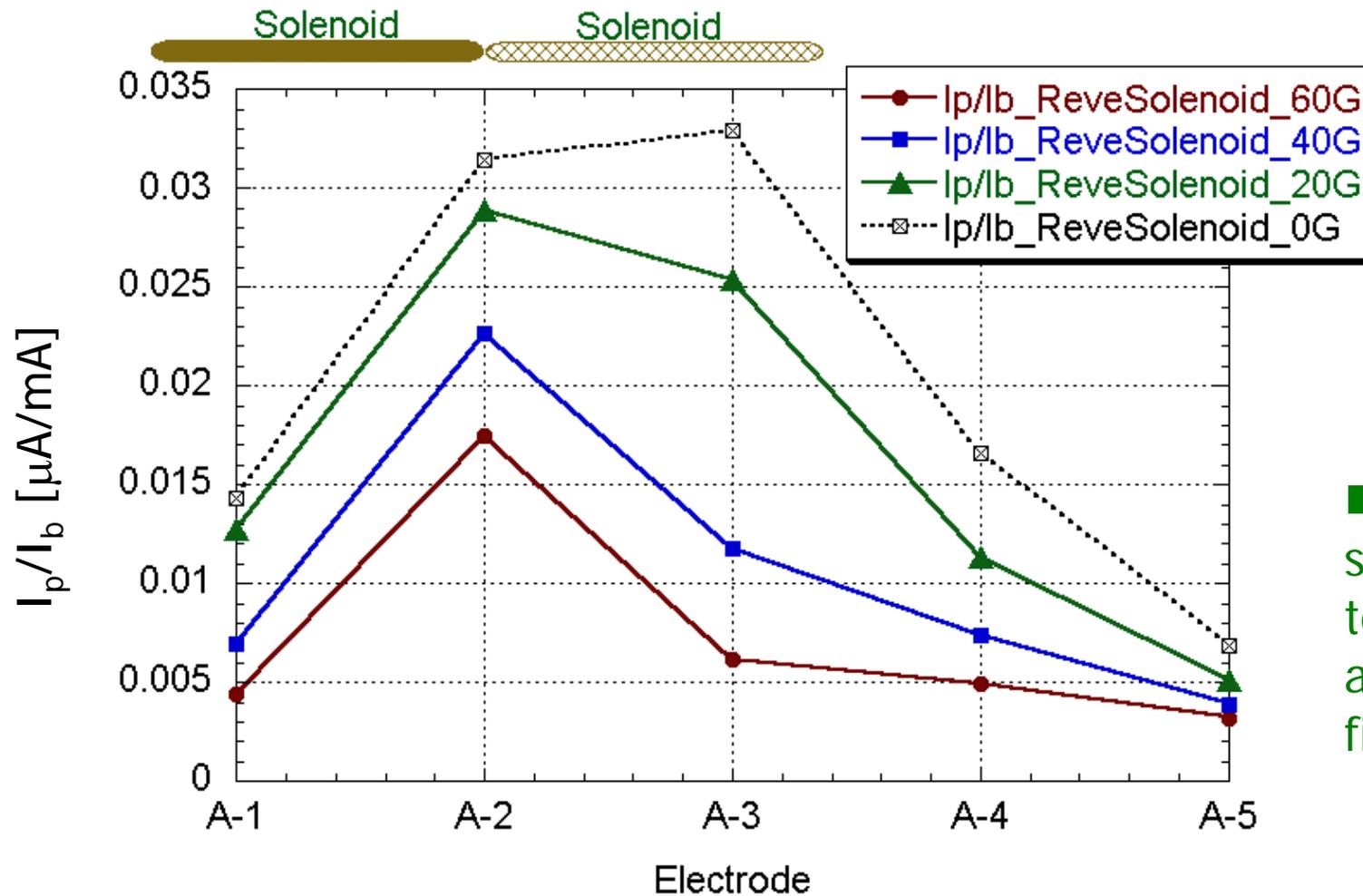
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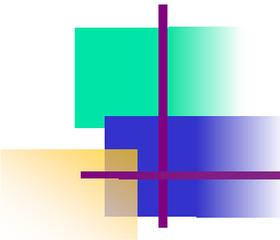
# Effect of Solenoid Field (Uniform)



# Effect of Solenoid Field (Non Uniform)



■ The previous solenoid was divided to a half and the alternative solenoid field was generated.



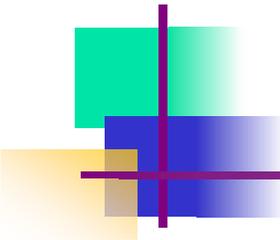
# Effect of Solenoid Field (Smooth)

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	Peak $I_p/I_b$ (A-1 – A-3)	Ratio to No Solenoid
No Solenoid	0.0345	1
Uniform 30G	0.0129	0.373(1/4)
Uniform 60G	0.00284	0.0823(1/12)
Uniform 90G	0.000992	0.0288(1/35)
Non Uniform 20G	0.0289	0.838
Non Uniform 40G	0.0226	0.655
Non Uniform 60G	0.0175	0.507(1/2)

# Effect of Solenoid Field (Saw-Tooth)

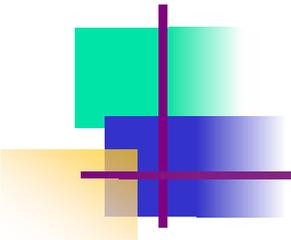
	Peak $I_p/I_b$	Ratio to No Solenoid	Ratio to No Solenoid (Smooth)
No Solenoid (Smooth)	0.0345	-	1
No Solenoid (Saw-Tooth)	0.00231	1	0.0670(1/15)
Uniform 30 G	0.000425	0.184(1/6)	0.0123(1/81)
Uniform 60 G	0.000108	0.0468(1/21)	0.00313(1/319)



# Effect of Positive Bias + Solenoid

- +70 V bias was applied.

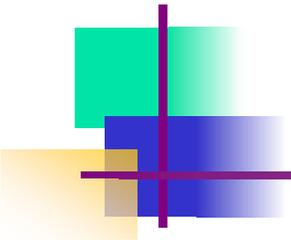
	Peak $I_p/I_b$	Ratio to No Solenoid	Ratio to No Solenoid (Smooth)
No Solenoid (Smooth)	0.242	-	1
42 G (Smooth)	0.0136	-	0.0562(1/18)
No Solenoid (Saw-tooth)	0.0224	1	0.0926(1/11)
42 G (Saw-tooth)	0.00101	0.0451(1/22)	0.00417(1/240)



# Summary

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- A saw-tooth surface was found to be effective to reduce the photoelectron yield, even for SR with a critical energy of 4.1 keV.
- The photoelectron yield for the saw-tooth surface was less than 6 % of that for the smooth surface.
- The external magnetic field was found to be useful to reduce the photoelectrons at the beam position. The uniformity of field was important to suppress the electrons effectively.
- The magnetic field larger than 50 G reduce the photoelectrons to less than 10 % at the beam position.



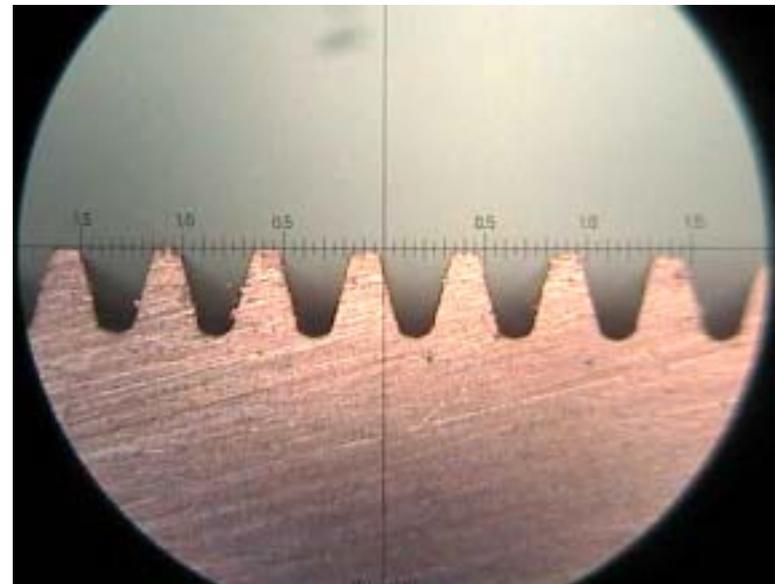
## Summary (Contd.)

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- Note here that a difference in our experiments and the real ring is the existence of a bunched positron beam, where the multipactoring phenomena may occur.
- Another difference is that there are many scattered photons in the ring. The saw-tooth surface should be prepared at whole inner surface.

# Test Chamber for Ring

- A 2.6m test chamber is under construction. It will be installed this winter.



2001/9/13